## N-CHANNEL 100V-0.12 $\Omega$-12A TO-252 LOW THRESHOLD POWER MOS TRANSISTOR

| TYPE | V $_{\text {DSS }}$ | $\mathbf{R}_{\text {DS(on) }}$ | ID $^{(120 \mathrm{~V}}$ |
| :---: | :---: | :---: | :---: |
| STD12N10L | $100.15 \Omega$ | 12 A |  |

- TYPICAL RDS(on) $=0.12 \Omega$
- AVALANCHE RUGGED TECHNOLOGY
- 100\% AVALANCHE TESTED
- HIGH CURRENT CAPABILITY
- $175{ }^{\circ} \mathrm{C}$ OPERATING TEMPERATURE
- LOW THRESHOLD DRIVE
- FOR THROUGH-HOLE VERSION CONTACT SALES OFFICE


## APPLICATIONS

- HIGH CURRENT, HIGH SPEED SWITCHING
- SOLENOID AND RELAY DRIVERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- DC-DC \& DC-AC CONVERTERS
- AUTOMOTIVE ENVIRONMENT(INJECTION, ABS, AIR-BG, LAMPDRIVERS, Etc.)


INTERNAL SCHEMATIC DIAGRAM


## ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DS}}$ | Drain-source Voltage $\left(\mathrm{V}_{\mathrm{GS}}=0\right)$ | 100 | V |
| $\mathrm{~V}_{\mathrm{DGR}}$ | Drain- gate Voltage $\left(\mathrm{R}_{\mathrm{GS}}=20 \mathrm{k} \Omega\right)$ | 100 | V |
| $\mathrm{~V}_{\mathrm{GS}}$ | Gate-source Voltage | $\pm 15$ | V |
| $\mathrm{I}_{\mathrm{D}}$ | Drain Current (continuous) at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 12 | A |
| $\mathrm{I}_{\mathrm{D}}$ | Drain Current (continuous) at $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | 8 | A |
| $\mathrm{I}_{\mathrm{DM}}(\bullet)$ | Drain Current (pulsed) | 48 | A |
| $\mathrm{P}_{\text {tot }}$ | Total Dissipation at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 50 | W |
|  | Derating Factor | 0.33 | $\mathrm{~W} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ | Storage Temperature | -65 to 175 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{j}}$ | Max. Operating Junction Temperature | 175 | ${ }^{\circ} \mathrm{C}$ |

(•) Pulse width limited by safe operating area

## THERMAL DATA

| $R_{\text {thj-case }}$ | Thermal Resistance Junction-case | Max | 3 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| :---: | :--- | :---: | :---: | :---: |
| $R_{\text {thj-amb }}$ | Thermal Resistance Junction-ambient | Max | 100 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $R_{\text {thc-sink }}$ | Thermal Resistance Case-sink | Typ | 1.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{T}_{1}$ | Maximum Lead Temperature For Soldering Purpose |  | 275 | ${ }^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS ( $\mathrm{T}_{\text {case }}=25^{\circ} \mathrm{C}$ unless otherwise specified)
OFF

| Symbol | Parameter | Test Conditions |  | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {(BR) } \mathrm{DSS}}$ | Drain-source <br> Breakdown Voltage | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A} \quad \mathrm{~V}_{\mathrm{GS}}$ |  | 100 |  |  | V |
| Idss | Zero Gate Voltage <br> Drain Current ( $\mathrm{V}_{\mathrm{GS}}=0$ ) | $\mathrm{V}_{\mathrm{DS}}=$ Max Rating <br> $V_{D S}=$ Max Rating | $\mathrm{T}_{\mathrm{c}}=125^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} \hline 1 \\ 10 \end{gathered}$ | $\begin{aligned} & \mu \mathrm{A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| IGss | Gate-body Leakage Current (VD $=0$ ) | $V_{G S}= \pm 15 \mathrm{~V}$ |  |  |  | $\pm 100$ | nA |

ON (*)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Gate Threshold Voltage | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}} \quad \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 1 | 1.6 | 2.5 | V |
| $\mathrm{R}_{\mathrm{DS}(o n)}$ | Static Drain-source On | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V} \quad \mathrm{I}_{\mathrm{D}}=6 \mathrm{~A}$ |  | 0.12 | 0.15 | $\Omega$ |
|  | Resistance | $\mathrm{V}_{\mathrm{GS}}=5 \mathrm{~V} \quad \mathrm{I}_{\mathrm{D}}=6 \mathrm{~A}$ |  | 0.17 | 0.2 | $\Omega$ |
| $\mathrm{I}_{\mathrm{D}(\text { on })}$ | On State Drain Current | $\mathrm{V}_{\mathrm{DS}}>\mathrm{I}_{\mathrm{D}(\text { on })} \times \mathrm{R}_{\mathrm{DS}(o n) \max }$ <br>  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}$ |  |  |  |

## DYNAMIC

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{g}_{\mathrm{fs}}(*)$ | Forward <br>  <br> Transconductance | $\mathrm{V}_{\mathrm{DS}}>\mathrm{I}_{\mathrm{D}(o n)} \times \mathrm{R}_{\mathrm{DS}(o n) \max } \quad \mathrm{I}_{\mathrm{D}}=6 \mathrm{~A}$ | 6.5 | 10 |  | S |
| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\mathrm{V}_{\mathrm{DS}}=25 \mathrm{~V} \quad \mathrm{f}=1 \mathrm{MHz} \quad \mathrm{V}_{\mathrm{GS}}=0$ |  | 800 |  | pF |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance |  |  | 150 | pF |  |
| $\mathrm{C}_{\text {rss }}$ |  |  |  | 50 | pF |  |
|  | Reverse Transfer |  |  |  |  |  |
| Capacitance |  |  |  |  |  |  |

ELECTRICAL CHARACTERISTICS (continued)
SWITCHING ON

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\mathrm{t}_{\mathrm{d}(\mathrm{on})}} \begin{gathered} \mathrm{t}_{\mathrm{r}} \end{gathered}$ | Turn-on Delay Time Rise Time | $\begin{array}{\|lr} \hline \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V} & \mathrm{I}_{\mathrm{D}}=6 \mathrm{~A} \\ \mathrm{R}_{\mathrm{G}}=4.7 \Omega & \mathrm{~V}_{\mathrm{GS}}=5 \mathrm{~V} \\ \text { (Resistive Load, see fig. 3) } & \\ \hline \end{array}$ |  | $\begin{aligned} & 15 \\ & 40 \end{aligned}$ |  | $\begin{aligned} & \text { ns } \\ & \text { ns } \end{aligned}$ |
| $\begin{gathered} Q_{g} \\ Q_{g s} \\ Q_{g d} \end{gathered}$ | Total Gate Charge Gate-Source Charge Gate-Drain Charge | $\mathrm{V}_{\mathrm{DD}}=80 \mathrm{~V} \mathrm{I}_{\mathrm{D}}=12 \mathrm{~A} \mathrm{~V}_{\mathrm{GS}}=5 \mathrm{~V}$ |  | $\begin{gathered} 20 \\ 6 \\ 10 \end{gathered}$ | 30 | $\begin{aligned} & \mathrm{nC} \\ & \mathrm{nC} \\ & \mathrm{nC} \end{aligned}$ |

## SWITCHING OFF

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{tr}_{\text {(Voff) }}$ | Off-voltage Rise Time | $\mathrm{V}_{\mathrm{DD}}=80 \mathrm{~V} \quad \mathrm{I}_{\mathrm{D}}=12 \mathrm{~A}$ |  | 12 |  | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Fall Time | $\mathrm{R}_{\mathrm{G}}=4.7 \Omega \quad \mathrm{~V}_{\mathrm{GS}}=5 \mathrm{~V}$ |  | 12 |  | ns |
| $t_{c}$ | Cross-over Time | (Inductive Load, see fig. 5) |  | 25 |  | ns |

## SOURCE DRAIN DIODE



Fig. 1: Unclamped Inductive Load Test Circuit


Fig. 3: Switching Times Test Circuits For Resistive Load


Fig. 2: Unclamped Inductive Waveform


Fig. 4: Gate Charge test Circuit


Fig. 5: Test Circuit For Inductive Load Switching And Diode Recovery Times


## TO-252 (DPAK) MECHANICAL DATA

| DIM. | mm |  |  | inch |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 2.2 |  | 2.4 | 0.086 |  | 0.094 |
| A1 | 0.9 |  | 1.1 | 0.035 |  | 0.043 |
| A2 | 0.03 |  | 0.23 | 0.001 |  | 0.009 |
| B | 0.64 |  | 0.9 | 0.025 |  | 0.035 |
| B2 | 5.2 |  | 5.4 | 0.204 |  | 0.212 |
| C | 0.45 |  | 0.6 | 0.017 |  | 0.023 |
| C2 | 0.48 |  | 0.6 | 0.019 |  | 0.023 |
| D | 6 |  | 6.2 | 0.236 |  | 0.244 |
| E | 6.4 |  | 4.6 | 0.252 |  | 0.260 |
| G | 4.4 |  | 10.1 | 0.173 |  | 0.181 |
| H | 9.35 |  |  |  |  | 0.397 |
| L2 |  |  |  |  |  |  |
| L4 | 0.6 |  |  | 0.023 |  | 0.031 |



## STD12N10L

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